

Low-Power Off-line Primary Side Regulation Controller**AP3772H****General Description**

The AP3772H is a high performance AC/DC power supply controller for battery charger and adapter applications. The device uses Pulse Frequency Modulation (PFM) method to build discontinuous conduction mode (DCM) flyback power supplies.

The AP3772H provides accurate constant voltage, constant current (CV/CC) regulation without requiring an opto-coupler and the secondary control circuitry. It also eliminates the need of loop compensation circuitry while maintaining good stability. The AP3772H can achieve excellent regulation and high average efficiency, yet meets no-load consumption less than 30mW. It can also achieve excellent dynamic performance while maintaining 30mW standby power with AP4340.

The AP3772H has a built-in fixed cable voltage drop compensation function. The magnitude of the cable compensation voltage is set as 3% of the rated output voltage. It also has an adjustable built-in line compensation function to achieve tight CC.

The AP3772H is available in SOT-23-6 package.

Features

- Primary Side Control for Tight Constant Current and Constant Voltage
- 30mW No-load Input Power
- Excellent Dynamic Performance with AP4340
- Bipolar Junction Transistor (BJT) Driving
- Proprietary Adjustable Line Compensation for CC Variation
- Constant and Built-in 6%, 3% and No Cable Voltage Drop Compensation
- Enhanced Audio Noise Suppression
- Open Circuit Protection
- Over Voltage Protection
- Short Circuit Protection
- SOT-23-6 package

Applications

- Adapters/Chargers for Cell/cordless Phones, PDAs, MP3 and Other Portable Devices
- LED Driver
- Standby and Auxiliary Power Supplies



Figure 1. Package Type of AP3772H

Pin Configuration

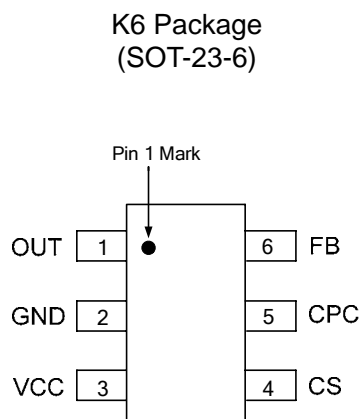


Figure 2. Pin Configuration of AP3772H (Top View)

Pin Description

Pin Number	Pin Name	Function
1	OUT	The OUT pin is used to turn on and turn off the power switch. When turning on the power switch, the OUT pin will output 30mA source current to support the base current of the power BJT. When turning off the power switch, the resistance between the OUT and GND will become to 5Ω
2	GND	The GND pin is the ground of the IC. When the power BJT is turned off, a fast reverse sinking current to the gate of BJT will flow out from this pin. Attention should be paid to in the PCB layout
3	VCC	The VCC pin supplies the power for the IC. In order to get the correct operation of the IC, a capacitor with low ESR should be placed as close as possible to the VCC pin
4	CS	The CS is the current sense pin of the IC. The IC will turn off the power BJT according to the voltage on the CS pin. When the power BJT is on, a current is output from the CS pin which is proportional to the line voltage to realize the function of line compensation
5	CPC	A capacitor more than 10nF should be connected to this pin. The voltage of CPC pin is linear to load of the system and it is used for the functions of cable voltage drop compensation and audio noise suppression
6	FB	The CV and CC regulation are realized based on the voltage sampling of this pin

**Low-Power Off-line Primary Side Regulation Controller****AP3772H****Ordering Information**

Package	Temperature Range	Cable Compensation Voltage	Part Number	Marking ID	Packing Type
SOT-23-6	-40 to 85°C	6%	AP3772HAK6TR-G1	GBC	Tape & Reel
		3%	AP3772HBK6TR-G1	GKJ	Tape & Reel
		0	AP3772HCK6TR-G1	GJD	Tape & Reel

BCD Semiconductor's Pb-free products, as designated with "G1" suffix in the part number, are RoHS compliant and green.

Absolute Maximum Ratings (Note 1)

Parameter	Symbol	Value	Unit
Supply Voltage	V_{CC}	-0.3 to 30	V
CS, CPC to GND		-0.3 to 7	V
FB Input Voltage	V_{FB}	-40 to 10	V
Source Current at OUT Pin	I_{SOURCE}	Internally Limited	A
Operating Junction Temperature	T_J	150	°C
Storage Temperature	T_{STG}	-65 to 150	°C
Lead Temperature (Soldering, 10 sec)	T_{LEAD}	300	°C
Thermal Resistance (Junction to Ambient)	θ_{JA}	200	°C/W

Note 1: Stresses greater than those listed under “Absolute Maximum Ratings” may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under “Recommended Operating Conditions” is not implied. Exposure to “Absolute Maximum Ratings” for extended periods may affect device reliability.



Low-Power Off-line Primary Side Regulation Controller

AP3772H

Electrical Characteristics

V_{CC}=15V, T_A=25°C, unless otherwise specified.

Parameter	Symbol	Conditions	Min	Typ	Max	Unit		
UVLO SECTION								
Startup Threshold	V _{TH} (ST)		13	15.5	18	V		
Minimal Operating Voltage	V _{OPR} (MIN)		3	3.5	4.5	V		
STANDBY CURRENT SECTION								
Startup Current	I _{ST}	V _{CC} =V _{TH} (ST)-1V, Before startup	0	0.2	0.6	μA		
Operating Current	I _{CC} (OPR)	Static current	250	500	600	μA		
DRIVE OUTPUT SECTION								
Output Current	Sink	I _{SINK}	Apply 1V @ OUT pin		150	330	500	mA
	Source	I _{SOURCE}			30	40	50	mA
Maximum Off Time	t _{OFF} (MAX)		14	18	25	ms		
CURRENT SENSE SECTION								
Current Sense Threshold Voltage at Heavy Load	V _{CS1}		500	525	550	mV		
Leading Edge Blanking	t _{LEB}	The minimum power switch turn on time	300	500	650	ns		
FEEDBACK INPUT SECTION								
Input Resistance of FB Pin	R _{FB}	V _{FB} =4V	1	1.6	2	MΩ		
Feedback Threshold	V _{FB}		3.98	4.04	4.1	V		
LINE COMPENSATION SECTION								
Line Compensation Transconductance (Note 2)	g _m		0.8	1.2	1.6	μS		
CABLE COMPENSATION SECTION								
Cable Compensation Voltage	ΔV _{FB_CABLE} / V _{FB} %	AP3772HA	5	6	7	%		
		AP3772HB	2	3	4			
		AP3772HC		0				
DYNAMIC FUNCTION SECTION								
Delay Time for Dynamic Function	t _D		110	150	200	μs		
Trigger Voltage for Dynamic Function	V _{TRIGGER}		120	150	180	mV		
PROTECTION SECTION								
Over Voltage Protection	V _{FB} (OVP)		7	8	9	V		
Maximum On Time of Primary Side	tonp (MAX)		20	35	50	μs		

Note 2: Line compensation voltage on CS pin: $\Delta V_{CS} = V_{IN_DC} \cdot \frac{N_{AUX}}{N_{PRI}} \cdot \frac{R_6}{R_6 + R_7} \cdot g_m \cdot R_{LINE}$



Typical Performance Characteristics

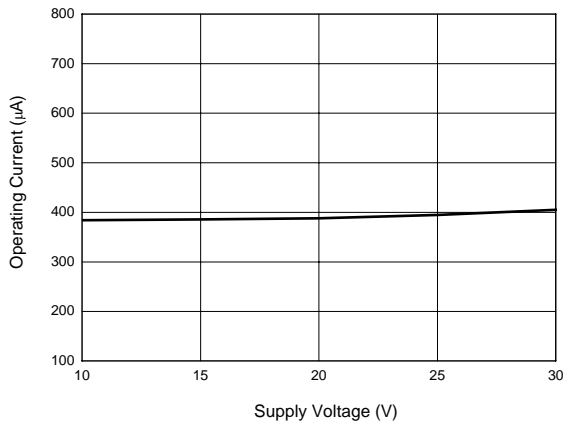


Figure 4. Operating Current vs. Supply Voltage

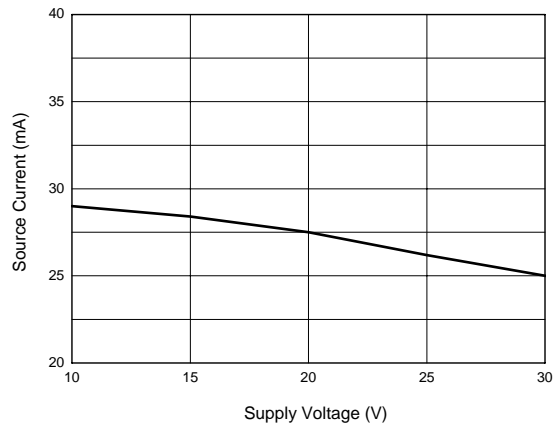


Figure 5. Source Current vs. Supply Voltage

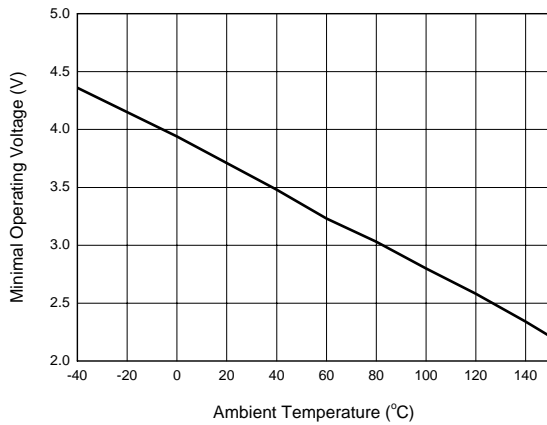


Figure 6. Minimal Operating Voltage vs. Ambient Temperature

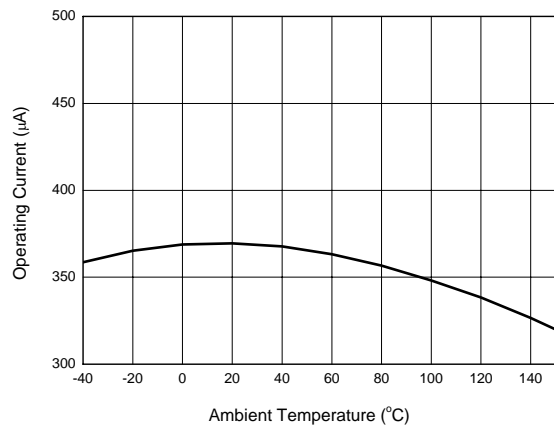


Figure 7. Operating Current vs. Ambient Temperature



Typical Performance Characteristics (Continued)

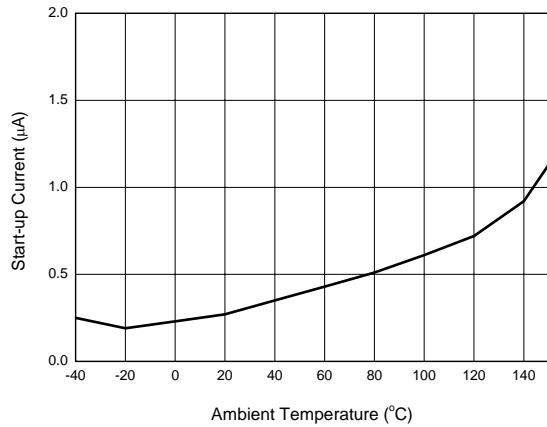


Figure 8. Start-up Current vs. Ambient Temperature



Figure 9. Start-up Voltage vs. Ambient Temperature



Figure 10. FB Input Resistance vs. Ambient Temperature



Figure 11. Source Current vs. Ambient Temperature



Typical Performance Characteristics (Continued)



Figure 12. Current Sense Voltage vs. Ambient Temperature

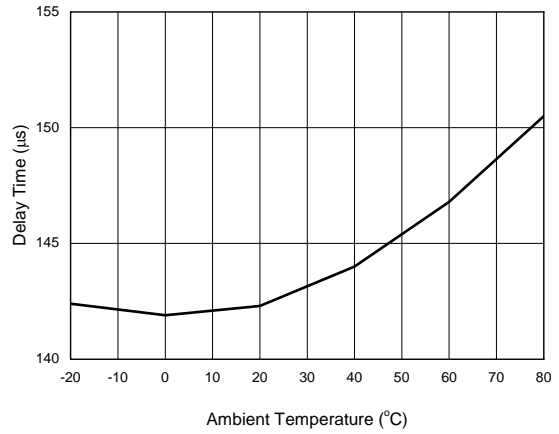


Figure 13. Delay Time vs. Ambient Temperature



Figure 14. Primary Side Maximum On Time vs. Ambient Temperature

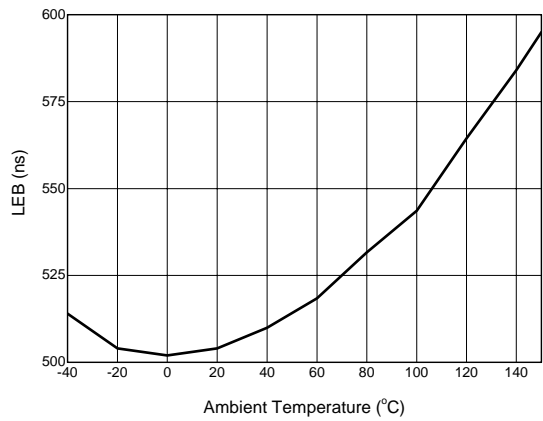


Figure 15. LEB vs. Ambient Temperature



Typical Performance Characteristics (Continued)

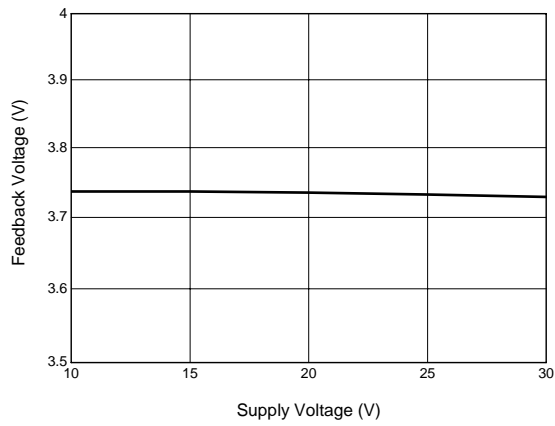


Figure 16. Feedback Voltage vs. Supply Voltage

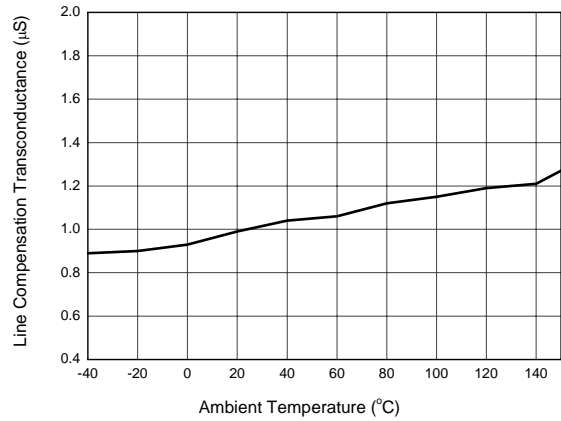


Figure 17. Line Compensation Transconductance vs. Ambient Temperature

Typical Application

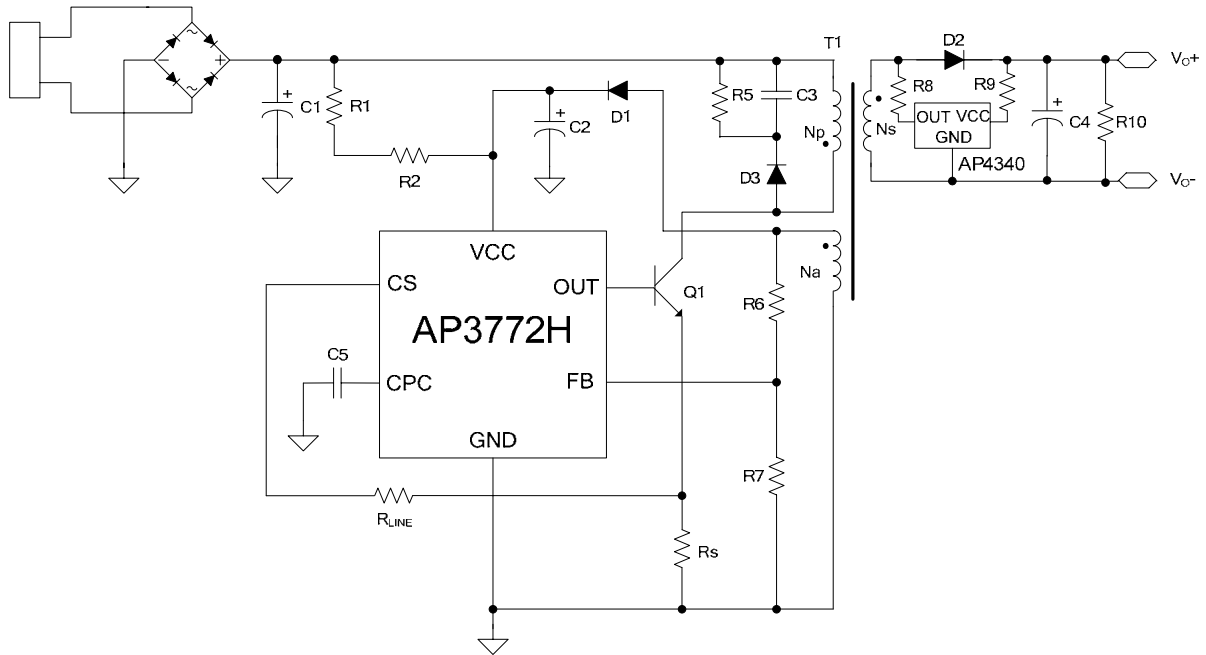


Figure 18. 5V/1A Output for Battery Charger of Mobile Phone
(The AP4340 Is Used to Achieve Fast Dynamic Response)

Mechanical Dimensions

SOT-23-6

Unit: mm(inch)





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